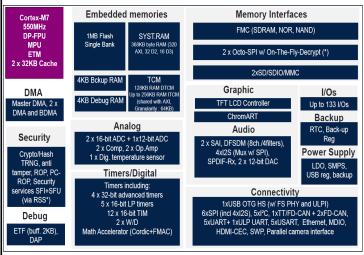
Xynergy^{XS2}

DSP Systeme Gmb

Versatile Controller module with STM32 Cortex-M7 Artix-7 FPGA, 128MB DDR3, 10/100 Ethernet, CAN, UART, USB-OTG, SDIO, I2C, ADC/DAC

Xynergy^{XS2} combines STMicroelectronics STM32H725 controller, based on ARM® Cortex™-M7, with a Xilinx Artix-7 FPGA XC7A50. The controller's FSMC interface is used for parallel 16-bit connection to the FPGA ensuring high-speed data transfer between the two devices. The STM32H725 core can be clocked up to 550 MHz and has up to 1 MB on-chip flash and 564 kB on-chip SRAM. In addition, the 1Gb (64M x 16) DDR-3 memory, which is connected to the FPGA, can be made transparent via the FSMC bus, allowing the controller to use it like external memory.

Xynergy^{XS2} micro-controller of the numerous communication interfaces, including 10/100 Ethernet with PHY, USB-OTG, CAN, SPI, COM-Ports (USART/UART), I2C, SDIO ports, ADC channels, DAC channels and general purpose I/O lines. All interface signals available at the 200-pin SO-DIMM edge connector are shown in the block diagram.



(*): on STM32H735 CPN (Crypto)

(**): CPN in "3" (Ex STM32H725ZGT3)

STM32F725 Block Diagram

The FPGA expands I/O capabilities of the **Xynergy**^{XS2} by delivering up to 35 differential (LVDS) I/O lines, useful for connecting FMC compliant expansion boards, and eight single-ended general purpose I/O lines.

For the pinout of the SO-DIMM connector, please contact DSP Systeme GmbH

A break-out board with all pins accessible at 100mil header plus JTAG headers is also available.

More information on this product and other products of **DSP GmbH** Systeme can be found https://dsp-sys.de



Specifications:

Power consumption: 3 Watts*) @ 3.3V (alternate V_{ccIO} for

FPGA Bank 15)

Micro-Controller: STM32H725 (H735 optional)

FPGA: Artix-7 XC7A50

External Memory: 128 MBytes DDR3, 64 Mbit SPI flash I/O: Up to 130 general purpose I/O pins, supporting

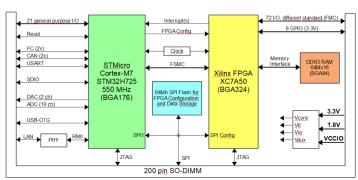
different I/O standards and protocols (see text)

Physical Dimensions: 67.6 x 30.0 x 6mm (SO-DIMM200)

Weight: approx. 6grams

Matching Socket: e.g., TE Connectivity 1473005-4 Bottom/Top Component Height: 2.0/2.0mm (max.)

*) depending on the application



Simplified Xynergy^{XS2} Block Diagram

Typical applications:

Point of Sale (PoS), Industrial Control, Industrial Imaging, Motion Control, M2M Communication etc.

> DSP Systeme GmbH Vohwinkelallee 8 40229 Düsseldorf / Germany Phone: +49-211-271 46 30 Fax: +49-211-210 81 76 Email: gmbh@dsp-sys.de

> > Web: https://dsp-sys.de